Power Transistors Panasonic

# 2SB1317

## Silicon PNP triple diffusion planar type

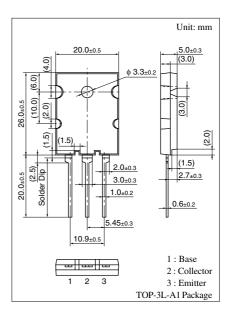
For high power amplification Complementary to 2SD1975

#### ■ Features

- $\bullet$  Excellent current  $I_C$  characteristics of forward current transfer ratio  $h_{FE}\ vs.\ collector$
- Wide area of safe operation (ASO)
- High transition frequency f<sub>T</sub>
- Optimum for the output stage of a Hi-Fi audio amplifier

### ■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter		Symbol	Rating	Unit
Collector to base voltage		$V_{CBO}$	-180	V
Collector to emitter voltage		$V_{CEO}$	-180	V
Emitter to base voltage		V <sub>EBO</sub>	-5	V
Peak collector current		$I_{CP}$	-25	A
Collector current		$I_{C}$	-15	A
Collector power	$T_C = 25^{\circ}C$	$P_{\rm C}$	150	W
dissipation	$T_a = 25^{\circ}C$		3.5	
Junction temperature		T <sub>j</sub>	150	°C
Storage temperature		$T_{stg}$	-55 to +150	°C



### ■ Electrical Characteristics $T_C = 25$ °C

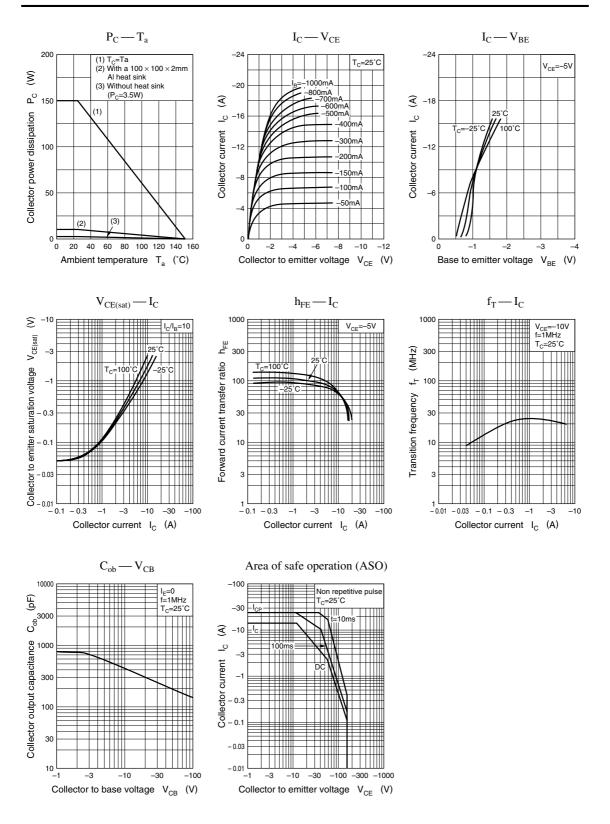
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector cutoff current	$I_{CBO}$	$V_{CB} = -180 \text{ V}, I_E = 0$			-50	μΑ
Emitter cutoff current	$I_{EBO}$	$V_{EB} = -3 \text{ V}, I_C = 0$			-50	μΑ
Forward current transfer ratio	h <sub>FE1</sub>	$V_{CE} = -5 \text{ V}, I_{C} = -20 \text{ mA}$	20			
	h <sub>FE2</sub> *	$V_{CE} = -5 \text{ V}, I_{C} = -1 \text{ A}$	60		200	
	h <sub>FE3</sub>	$V_{CE} = -5 \text{ V}, I_C = -8 \text{ A}$	20			
Base to emitter voltage	$V_{BE}$	$V_{CE} = -5 \text{ V}, I_C = -8 \text{ A}$			-1.8	V
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = -10 \text{ A}, I_{\rm B} = -1 \text{ A}$			-2.5	V
Transition frequency	$f_T$	$V_{CE} = -5 \text{ V}, I_C = -0.5 \text{ A}, f = 1 \text{ MHz}$		20		MHz
Collector output capacitance	$C_{ob}$	$V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		450		pF

Note) \*: Rank classification

Rank	Q	S	Р	
h <sub>FE2</sub>	60 to 120	80 to 160	100 to 200	

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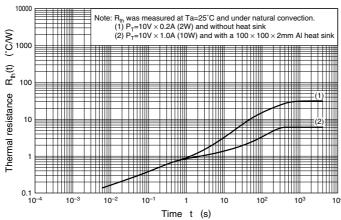
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